

### Getting started with X-NUCLEO-53L1A1 long distance ranging ToF sensor expansion board based on VL53L1X for STM32 Nucleo

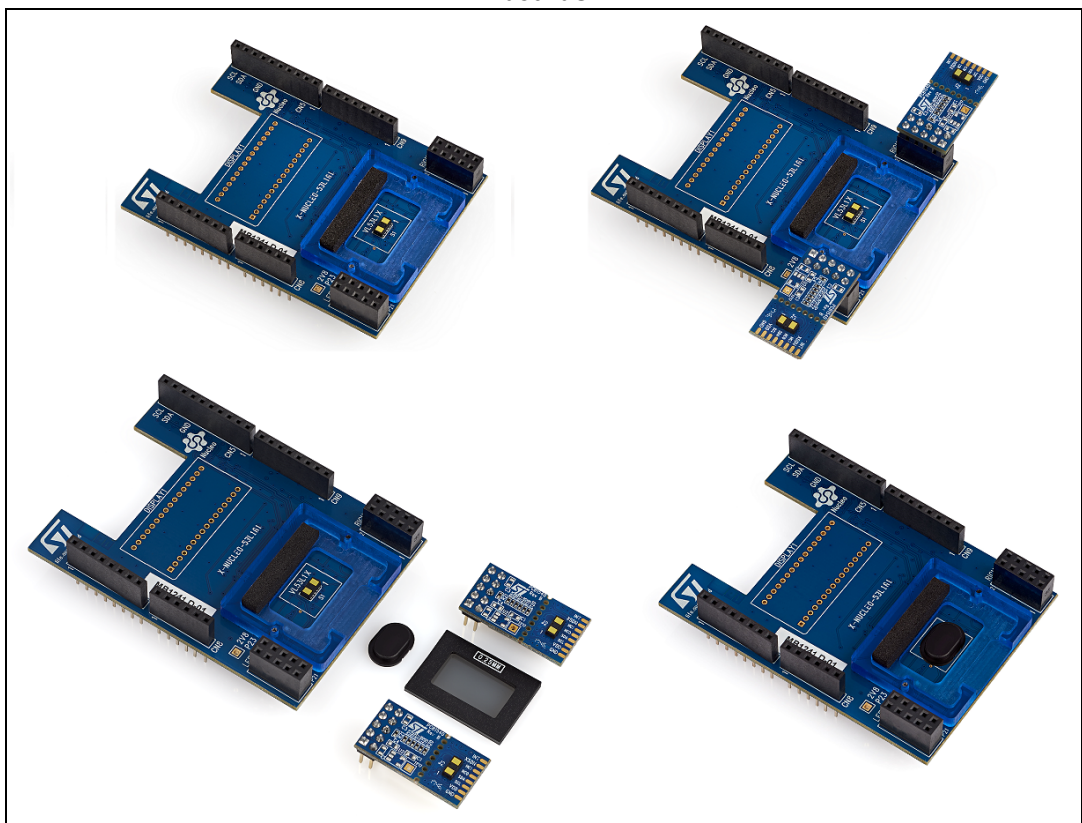
#### Introduction

This document provides detailed hardware information on the X-NUCLEO-53L1A1 expansion board. This expansion board is compatible with the STM32 Nucleo family and the Arduino™ electronic boards. It is designed around the VL53L1X ranging sensor and is based on the ST patented FlightSense™ technology.

To allow the user to validate the VL53L1X in an environment as close as possible to its final application, the X-NUCLEO-53L1A1 expansion board is delivered with a holder in which three different height spacers of 0.25, 0.5, and 1 mm can be fitted with the cover glass above the spacer. The height spacers are used to simulate different air gap distances between the VL53L1X sensor and the cover glass.

The X-NUCLEO-53L1A1 expansion board is delivered with two VL53L1X breakout boards.

**Figure 1. X-NUCLEO-53L1A1 expansion board, spacers, cover glass, and breakout boards**



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# Contents

- 1 Overview ..... 3**
- 2 Document references ..... 3**
- 3 X-NUCLEO-53L1A1 expansion board ..... 4**
  - 3.1 Overview ..... 4
  - 3.2 Electrical schematic and list of materials ..... 8
    - 3.2.1 Electrical schematic ..... 8
    - 3.2.2 List of materials ..... 9
  - 3.3 Solder drop configurations ..... 10
  - 3.4 Integrated device pinning ..... 12
- 4 VL53L1X breakout board ..... 13**
- 5 Safety ..... 15**
  - 5.1 Electrostatic precaution ..... 15
  - 5.2 Laser considerations ..... 15
- 6 Revision history ..... 16**

# 1 Overview

The X-NUCLEO-53L1A1 expansion board features the VL53L1X ranging sensor, based on ST’s FlightSense™, Time-of-Flight (ToF) technology.

It is compatible with the STM32 Nucleo development board family, and with the Arduino UNO R3 connector layout.

Several ST expansion boards can be stacked through the Arduino connectors, which allows, for example, the development of VL53L1X applications with Bluetooth or Wi-Fi interfaces.

The X-NUCLEO-53L1A1 expansion board is delivered with:

- Three spacers of 0.25, 0.5, and 1 mm height, used to simulate different air gaps between the VL53L1X and the cover glass.
- Two cover windows to simulate the integration of the VL53L1X into the customer’s final product.
- Two VL53L1X breakout boards which can be plugged onto the X-NUCLEO-53L1A1 expansion board or connected through flying wires to the X-NUCLEO-53L1A1 expansion board.
- Two 10-pin connectors to enable the customer to connect the two breakout boards onto the X-NUCLEO-53L1A1 expansion board.

*Note: The VL53L1X is delivered with a liner to prevent potential foreign material from penetrating inside the module holes during the assembly process. This liner must be removed at the latest possible step during final assembly, before module calibration.*

**Table 1. Ordering information**

Order code	Description
X-NUCLEO-53L1A1	STM32 Nucleo expansion board - spacers and glass - two breakout boards

# 2 Document references

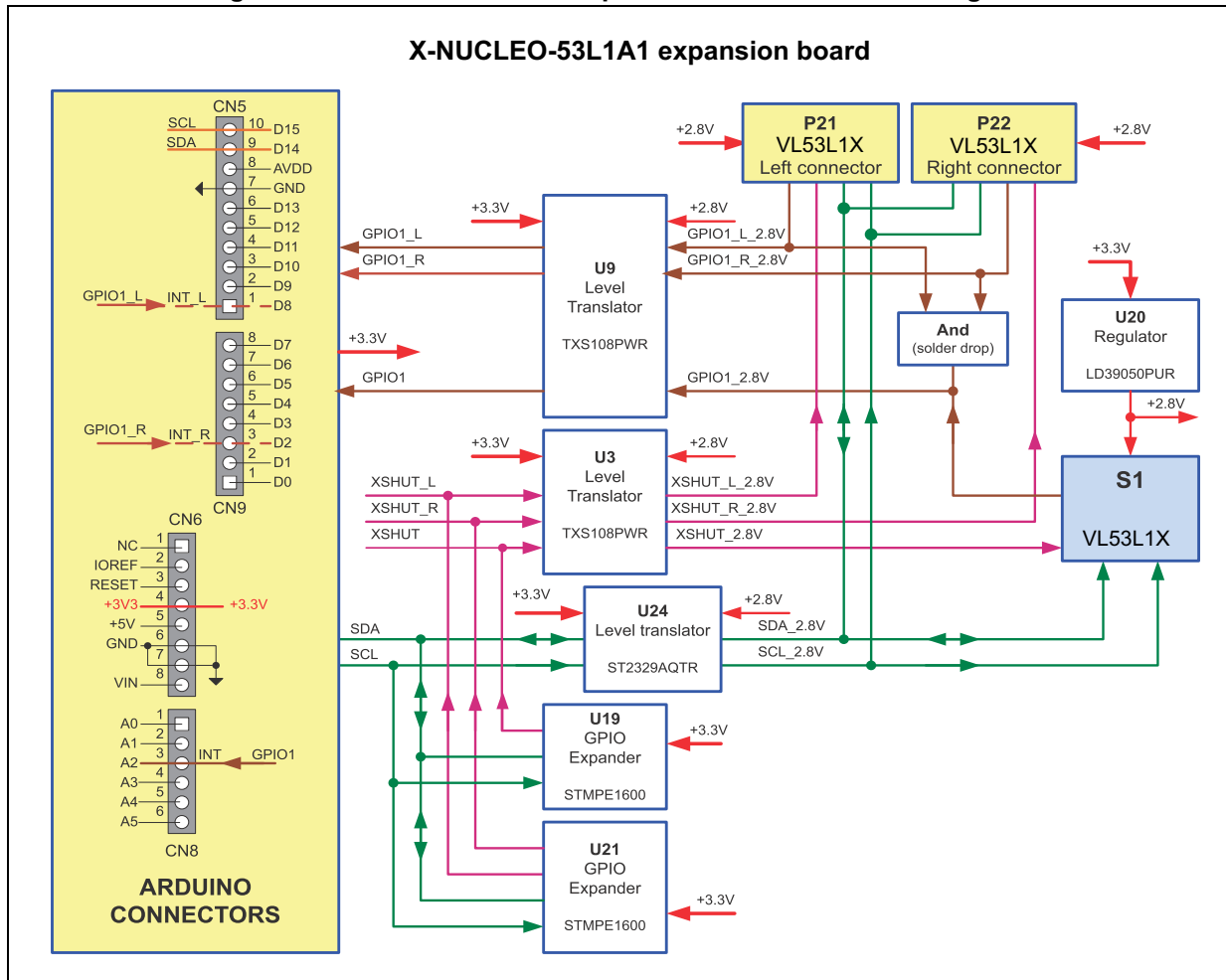
**Table 2. Document references**

Description	DocID
VL53L1X datasheet	DS12385
X-NUCLEO-53L1A1 data brief	DB3479
P-NUCLEO-53L1A1 data brief	DB3477
X-CUBE-53L1A1 data brief	DB3523
Getting started with the X-CUBE-53L1A1 Time-of-Flight long distance ranging sensor software expansion for STM32Cube	UM2371

### 3 X-NUCLEO-53L1A1 expansion board

This section describes the X-NUCLEO-53L1A1 expansion board features and provides useful information for understanding the electrical characteristics.

Figure 2. X-NUCLEO-53L1A1 expansion board schematic diagram



#### 3.1 Overview

The board allows the user to test the VL53L1X functionality, to program it and to understand how to develop an application using the VL53L1X. It integrates:

- 2.8 V regulator to supply the VL53L1X
- Level translators to adapt the I/O level to the main board of the microcontroller
- Arduino UNO R3 connectors
- Optional VL53L1X breakout board connectors
- Solder drops to allow different configurations of the expansion board

It is fundamental to program a microcontroller to control the VL53L1X through the I2C bus. The application software and an examples of the C-ANSI source code are available on [www.st.com/VL53L1X](http://www.st.com/VL53L1X).

The X-NUCLEO-53L1A1 expansion board and STM32 Nucleo development board are connected through the Arduino™ UNO R3 connectors CN5, CN6, CN8, and CN9 as shown in *Figure 3* and as described in *Table 3* and *Table 4*.

The X-NUCLEO-53L1A1 must be plugged onto the STM32 Nucleo development board through the Arduino™ UNO R3 connectors.

**Figure 3. X-NUCLEO-53L1A1 expansion board connector layout**

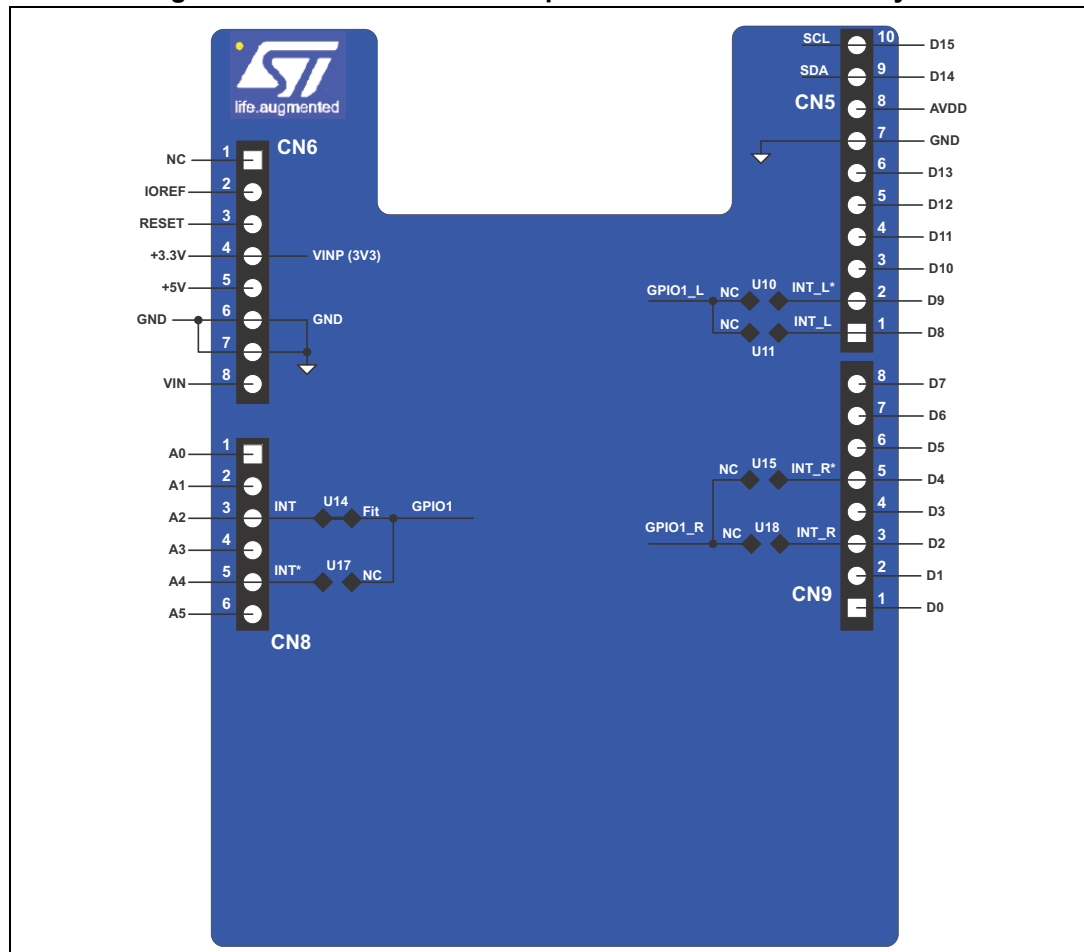


Table 3. Left Arduino connector

CN number	VL53L1X board	Pin number	Pin name	MCU pin	X-NUCLEO-53L1A1 expansion board function	
CN6 power		1	NC	NC	Not used	
		2	NC	IOREF		
		3	NC	RESET		
	Power	4	3V3	3V3	3.3 V supply	
		5	NC	5V	Not used	
	Gnd	6	Gnd	Gnd	Gnd	
	Gnd	7	Gnd	Gnd		
			8	NC	VIN	Not used
CN8 analog		1	NC	PA0		
		2	NC	PA1		
	GPIO1	3	INT	PA4	Interrupt signal from VL53L1X on board soldered device	
		4	NC	PB0	Not used	
	GPIO1	5	INT*	PC1 <sup>(1)</sup>	By default not used, interrupt signal from VL53L1X on board soldered device	
		6	NC	PC0	Not used	

1. Depends on STM32 Nucleo board solder bridges, see details in [Section 3.3: Solder drop configurations](#). These interrupt signals are duplicated, but not used. This offers hardware connection flexibility in case of conflict on the MCU interface management when the expansion board is used superimposed with other expansion boards. In this case, remove the solder drop from the used interrupt and instead, fit the solder drop in "NC".

Table 4. Right Arduino connector

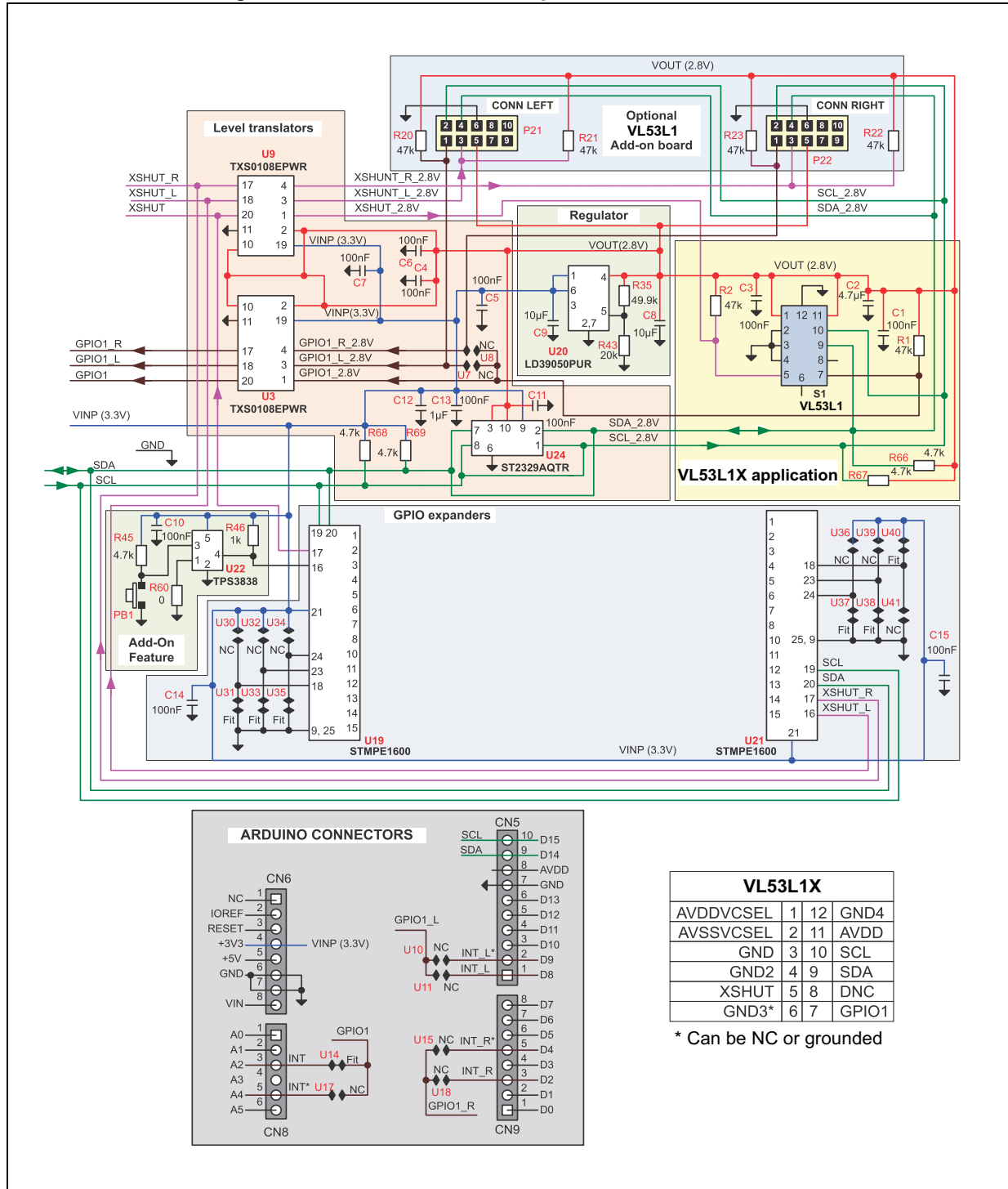
CN number	VL53L1X board	Pin number	Pin name	MCU pin	X-NUCLEO-53L1A1 expansion board function
CN5 digital	SCL	10	D15	PB8	I2C1_SCL
	SDA	9	D14	PB9	I2C1_SDA
		8	NC	AVDD	Not used
	Gnd	7	Gnd	Gnd	Gnd
		6	INT_L	PA5	Not used
		5	NC	PA6	
		4	NC	PA7	
		3	NC	PB6	
	GPIO1_L	2	INT_L*	PC7	By default not used, interrupt signal from optional VL53L1X left breakout board <sup>(1)</sup>
GPIO1_L	1	INT_L	PA9	By default not used, interrupt signal from optional VL53L1X left breakout board <sup>(1)</sup>	
CN9 digital		8	NC	PA8	Not used
		7	NC	PB10	
		6	NC	PB4	
	GPIO1_R	5	INT_R*	PB5	By default not used, interrupt signal from optional VL53L1X right breakout board <sup>(1)</sup>
		4	NC	PB3	Not used
	GPIO1_R	3	INT_R	PA10	By default not used, interrupt signal from optional VL53L1X right breakout board <sup>(1)</sup>
		2	NC	PA2	Not used
		1	NC	PA3	

1. These interrupt signals are duplicated, but not used by default. This offers hardware connection of the breakout board VL53L1X interrupt signals and flexibility in case of conflict on the MCU interface management when the expansion board is used superimposed with other expansion boards. In this case, select, through a solder drop, the MCU port which is free.

### 3.2 Electrical schematic and list of materials

#### 3.2.1 Electrical schematic

Figure 4. X-NUCLEO-53L1A1 expansion board schematic





### 3.2.2 List of materials

Table 5. List of materials

Components	Value	Reference	Supplier	Comments
<b>VL53L1X application</b>				
C1, C3	100 nF	X5R		Supply voltage decoupling
C2	4.7 $\mu$ F	X5R - 6.3 V		
R1	47 k			Interrupt output pull up
R2	47 k			Reset input pull up
R66, R67	4.7 k			SDA and SCL line pull up at 2.8 V
S1		VL53L1X	ST	ToF ranging sensor
<b>VL53L1X breakout board interfaces</b>				
R20	47 k			Left breakout board interrupt output pull up
R21	47 k			Left breakout board reset input pull up
R22	47 k			Right breakout board reset input pull up
R23	47 k			Right breakout board interrupt output pull up
<b>2.8 V regulator application</b>				
C8	10 $\mu$ F	X5R - 6.3 V		Output voltage decoupling
C9	10 $\mu$ F	X5R - 6.3 V		Input voltage decoupling
R35	49.9 k			Feedback resistor bridge to set the output voltage to 2.8 V
R43	20 k			
U20		LD39050PUR	ST	Output programmable regulator
<b>Level translator application</b>				
C4, C6, C11	100 nF			2.8 V decoupling capacitor
C5, C7, C13	100 nF			3.3 V decoupling capacitor
C12	1 $\mu$ F	X5R - 6.3V		
R68, R69	4.7 k			SDA and SCL line pull up at 3.3 V
U3, U9		TXS0108PWR	TI	For all signals except I2C interface
U24		ST2329AQTR	ST	For I2C interface
<b>Add-on feature</b>				
C10	100 nF			Supply decoupling capacitor
R45	4.7 k			Push-button pull up
R46	1 k			Output pull up
R60	0			Delay time setting (def = 10 ms)

Table 5. List of materials (continued)

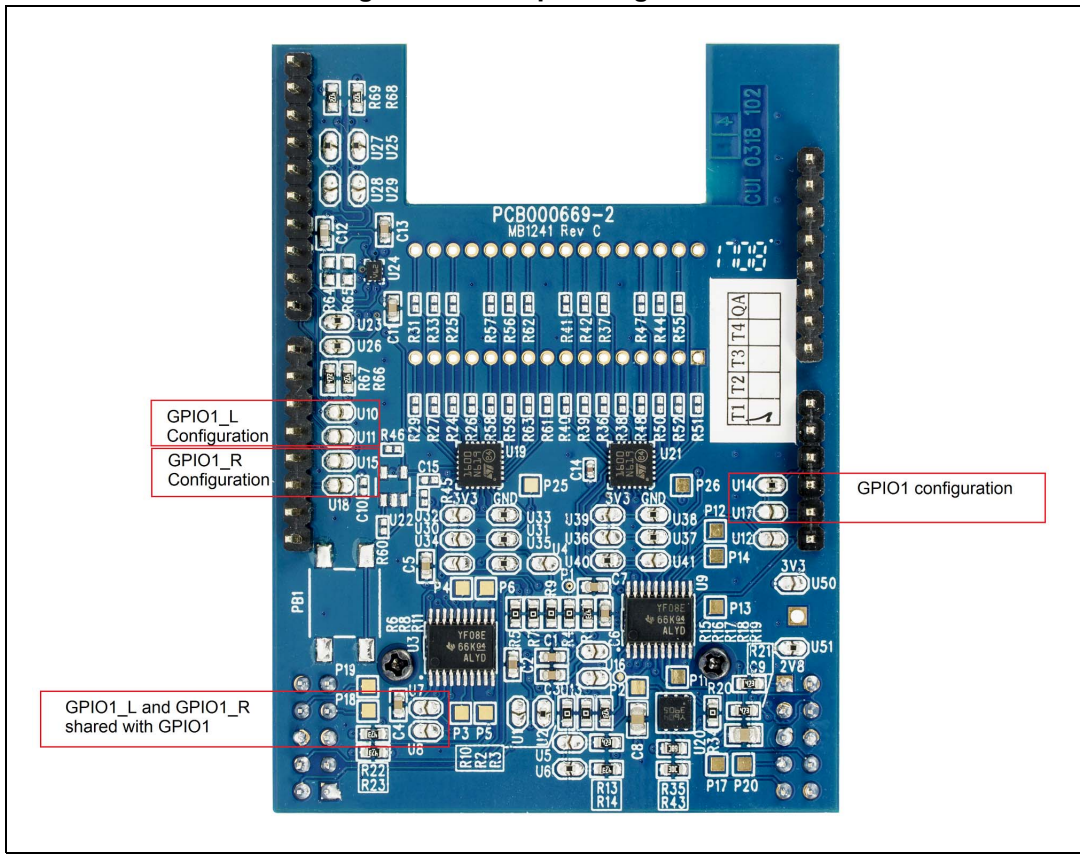
Components	Value	Reference	Supplier	Comments
PB1				Push button
U22		TPS3838K33	TI	Supervisory circuit
<b>GPIO expander</b>				
C14, C15	100 nF			Supply decoupling capacitor

### 3.3 Solder drop configurations

Solder drops allow the following configurations of the X-NUCLEO-53L1A1 expansion board:

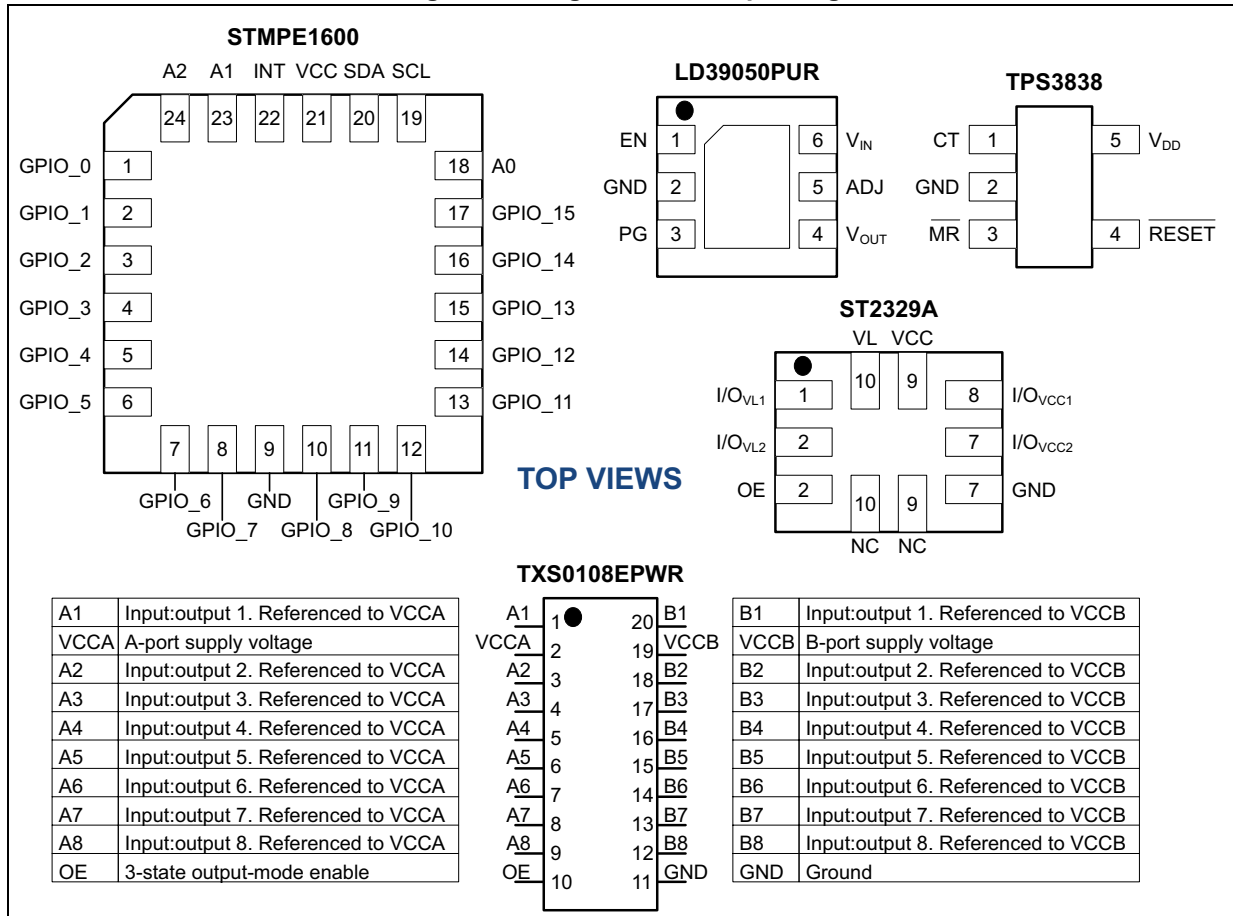
- If the developer wants to make an application with several expansion boards stacked and there is:
  - conflict with the microcontroller port allocation, the GPIO1 can be output on the CN8/A4 (U17 fitted) of the Arduino connector. The default configuration is that GPIO1 is output on the CN8/A2 (U14 fitted) of the Arduino connector.
  - conflict on the I2C addresses, the addresses of the STMPE1600 can be modified (the default addresses A2, A1, A0, 000, and 001).
- If the developer wants to connect breakout boards (see [Figure 5](#)) to the X-NUCLEO-53L1A1 expansion board:
  - the VL53L1X interrupt of the left breakout board can be output on the CN5/D9 (U10 fitted) or CN5/D8 (U11 fitted) of the Arduino connector. By default, the U10 and U11 are not fitted.
  - the VL53L1X interrupt of the right breakout board can be output on the CN9/D4 (U15 fitted) or CN9/D2 (U18 fitted) of the Arduino connector. By default, the U15 and U18 are not fitted.
  - the VL53L1X interrupts of the left and right breakout boards, GPIO1\_L and GPIO1\_R, can be shared with the VL53L1X interrupt on the main board, GPIO1, by fitting U7 and U8 solder drops. By default U7 and U8 are not fitted.

Figure 5. Interrupt configurations



### 3.4 Integrated device pinning

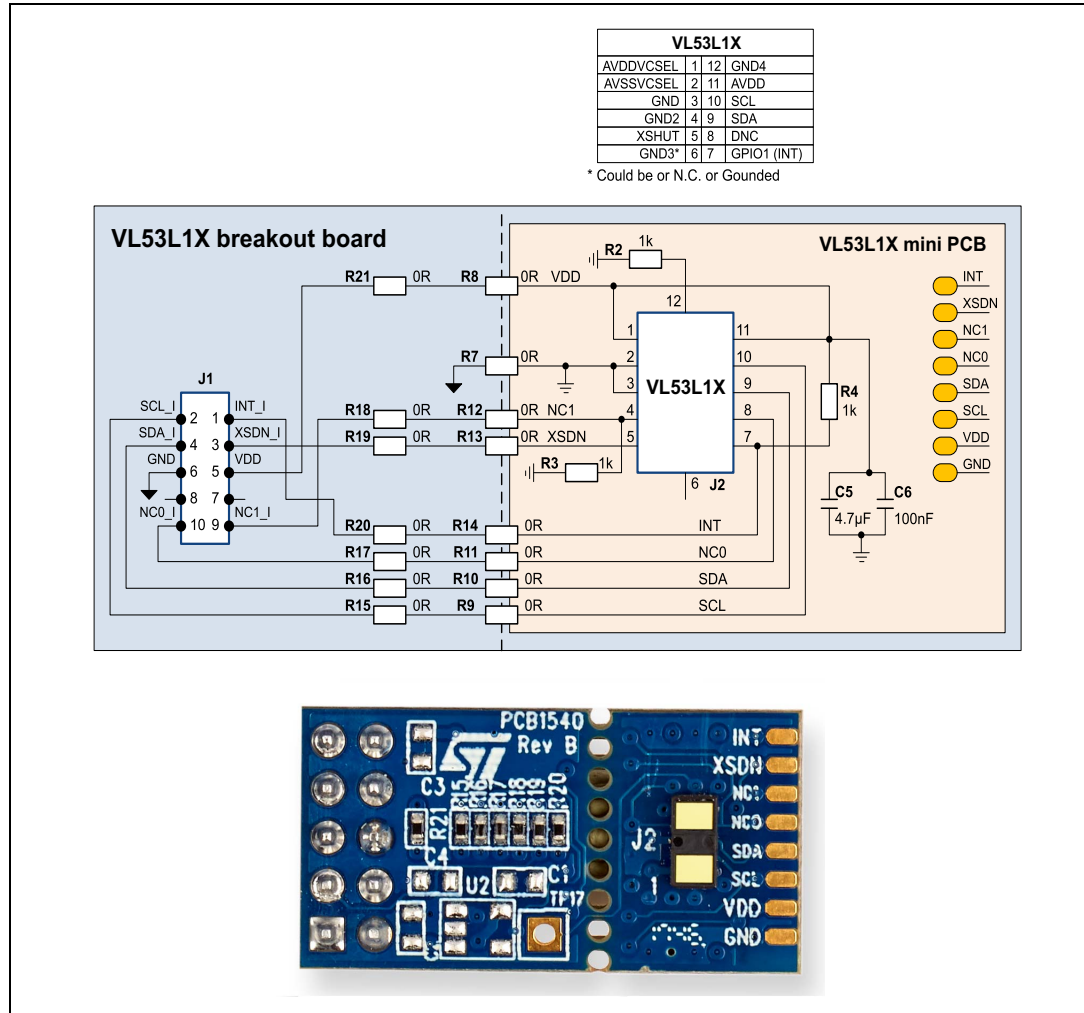
Figure 6. Integrated device pinning



# 4 VL53L1X breakout board

The VL53L1X breakout boards are supplied at 2.8 V by the regulator present on the X-NUCLEO-53L1A1 expansion board.

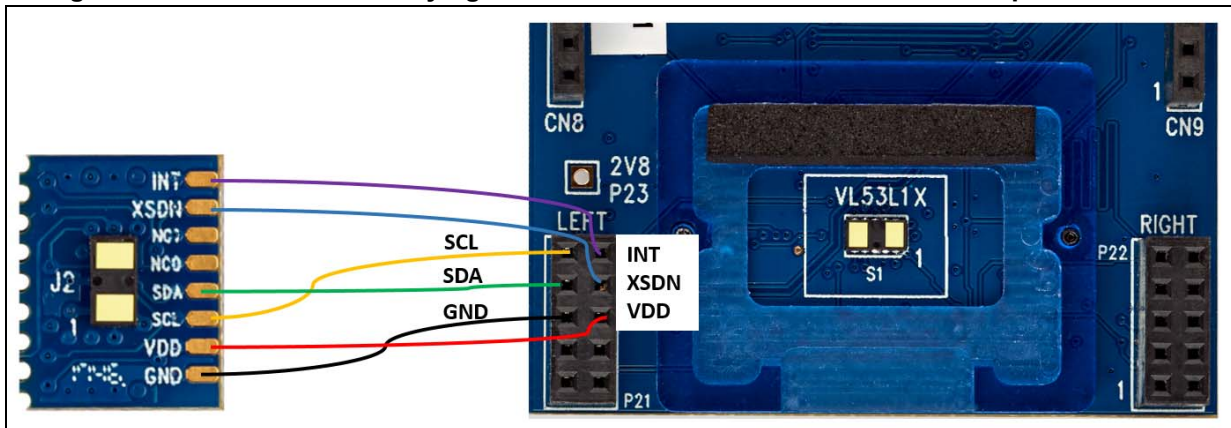
Figure 7. VL53L1X breakout board schematic



The VL53L1X breakout boards can be directly plugged onto the X-NUCLEO-53L1A1 expansion board through the two 10-pin connectors or connected to the board through flying leads.

When connected through flying leads, developers should break off the mini PCB from the breakout board, and use only the “VL53L1X mini PCB” which because of its small size, is easier to integrate into customers devices.

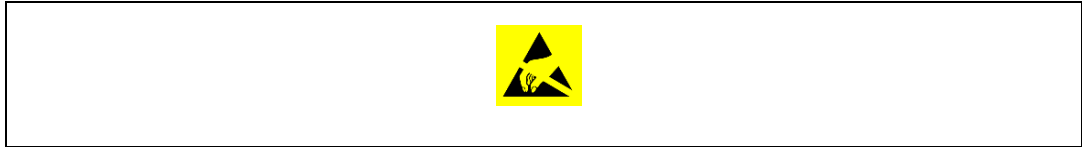
Figure 8. VL53L1X mini PCB flying lead connection to X-NUCLEO-53L1A1 expansion board



## 5 Safety

### 5.1 Electrostatic precaution

Figure 9. Electrostatic logo



The user should exercise electrostatic precautions, including using ground straps when using the X-NUCLEO-53L1A1 expansion board. Failure to prevent electrostatic discharge could damage the device.

### 5.2 Laser considerations

The VL53L1X contains a laser emitter and corresponding drive circuitry. The laser output is designed to remain within Class 1 laser safety limits under all reasonably foreseeable conditions including single faults, in compliance with the IEC 60825-1:2014 (third edition). The laser output remains within Class 1 limits as long as STMicroelectronics' recommended device settings are used and the operating conditions specified in the datasheet are respected. The laser output power must not be increased by any means and no optics should be used with the intention of focusing the laser beam.

Figure 10. Class 1 laser product label



## 6 Revision history

**Table 6. Document revision history**

Date	Revision	Changes
07-03-2018	1	Initial release



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